Analyzing Deflection and Torsion of MEMS Bridge

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Abstract

In this paper we discuss and compare regarding various methods in analyzing deflection of MEMS Bridge that the deflection occurs due to a point force and distributed force. We solved deflection of a bridge under the electrostatics forces by considering the linear and nonlinear methods and by comparing the results, we calculated that in which range of dimension the linearity has good accuracy. For this purpose first in Macsyma we wrote a code to solve the nonlinear differential equation numerically and draw the results and solved linear O.D.E. using definite methods, comparing the results then rescaling the all dimensions and forces, we could get the acceptable range of linearity. Then we solved the same problem by Ansys in two cases, linear element and nonlinear element, and then compared the results of Ansys with Macsyma. The results showed that nonlinearity increases exponentially by decreasing the dimensions. Finally, we compare the effect of point force and distributed force on linear and nonlinear analysis. The results showed that increasing the force increases the nonlinearity.

Keywords— Deflection, Micromechanical switches, MEMS Bridge, RF MEMS switches, Newtonian laws, Torsion.

1. INTRODUCTION

Development in MEMS technology has made possible the design and fabrication of control devices suitable for switching microwave signals. Micromechanical switches were first demonstrated in 1979 [1] as electrostatically actuated cantilever switches used to switch low frequency electrical signals. Since then, these switches have demonstrated useful performance at microwave frequencies using cantilever [2], [3], rotary [4], and membrane topologies [5], [6]. These switches have shown that moving metal contacts possess low parasitics at microwave frequencies (due to their small size) and are amenable to achieving low on-resistance (resistive switching) or high on-capacitance (capacitive switching).

Micromechanical membrane switches have several advantages compared to FET or p-n diode switches. Eliminating the use of semiconductor p-n and metal-semiconductor junctions in radio frequency (RF) devices serves three very useful functions. First, the contact and spreading resistance associated with ohmic contacts are eliminated, significantly reducing the resistive losses in the device. Instead, high conductivity films are used to fabricate metal structures that carry RF currents with ultra-low losses. Second, the removal of

nonlinearities associated with semiconductor junctions significantly improve the distortion characteristics and power handling of the RF MEMS devices. RF MEMS switches exhibit no measurable harmonics or intermodulation distortion. Meanwhile, the power handling of these devices is limited mostly by current density limitations. Third, electrostatic operation of the mechanical motion of MEMS devices requires negligible quiescent current RF consumption. Typical switching energy is approximately 10 nJ. The main limitation of these switches is their switching speed. Microsecond switching precludes their use in high-speed applications such as transmit/receive switching. However, these speeds are more than sufficient for a variety of applications including beam steering in phased antenna arrays. This paper describes significant improvements to the design of metal membrane switches which operate with significantly reduced losses, increased operating frequencies, and improved switching speeds over previously reported work.

Mechanic laws which governing on MEMS Mostly have not investigated, so all O.D.E's or. P.D.E's are Newtonian laws .but the other point in MEMS is Where we can use linear analysis [1,4,6,7,9,11,13] and where we must use nonlinear analysis [2,3,5,8,10,12].

In some cases researchers consider the behavior of system nonlinear and solve the nonlinear differential equation [2,5,10,12]. In some cases they consider the system nonlinear but try to linearism the differential equation [3,7,8,13]. Otherwise we consider linear equation and solve it [1,4,6,9,11].

In this work we try to show that from which range of dimension nonlinearity becomes important for bending of a MEMS switch membrane, and how much is it's value. So in different cases we solve:

$$\frac{\frac{d^2 y}{d x^2}}{((1 + (\frac{dy}{dx})^2)^{\frac{3}{2}}} = \frac{M(x)}{E \times I}$$
(1)

As a nonlinear equation and

$$\frac{d^2 y}{dx^2} = \frac{M(x)}{E \times I} \tag{2}$$

As linear O.D.E, which is commend in Macromechanics

2. Membrane properties

Below shows two figures of MEMS membrane which is fabricated by Texas Ins. Co. The side-view architecture of one such MEMS switch is shown in Fig. 1(a). The switches are manufactured on a GaAs substrate, over which a "bow-tie" metal membrane is deposited by evaporation. The material used in the membrane is an aluminum alloy. This membrane is the only moving part of the device. Its shape, size and mechanical properties determine the behavior of the MEMS switch. Two of its edges are attached to thin posts that maintain it suspended over an insulated electrode. Microfabrication details and employed materials have been reported by Goldsmith et al.4,6 Switching is achieved by applying a pulling-in voltage between the membrane and the bottom electrode. Figure 1(b) shows the top view of a switch together with its dimensions. The membrane thickness is 300 nm with a variability of 10 nm from membrane to membrane. The gray circular dots over the membrane are small holes, 2 µm in diameter, which are necessary for plasma etching of the polymersacrificial layer. These holes also play a role in the dynamic behavior of the switch, by providing viscous damping, if actuated in an inert gas or air.



Fig. 1—(a) Cross-section of MEMS RF, switch. (b) Optical micrograph of the "bow-tie" membrane mounted on posts. The membrane is made of the same aluminum alloy used in the microfabrication of the Digital Micromirror Array Device developed by Texas Instruments Co., and contains a pattern of holes for membrane release during plasma etching. All dimensions are in micrometers.

3. Solution of O.D.E for point force

For solving the nonlinear O.D.E (1), in first step we tried to cache a solution by Lie groups, perturbation but we couldn't reach any result, so we tried to solve numerically the O.D.E. Using the ready numerical packages of software isn't possible, because they don't work for MEMS dimensions. So we wrote a program in Macsyma to solve the O.D.E (2) by Runge-kutta method and exact solution for (1).this program, which can be considered as a function

of software, accepts the below table's data for run. The moment is defined as

$$M = \frac{a}{2} \times \left(\frac{l}{4} - x\right)^{m}$$

runge(n,1,y0,dy0,a,m,e,ii):=
Fig2-The shape of function

	-	Table	1		
	the argui	nent o	of function		
n	number differences	of	Y0	B.C	
1	length		dy0	B.C	
а	Coefficient moment	of	m	Power moment	of
e	Module elasticity	of	ii	Momentu of inertia	ım

and draws the graph of both deflections and the difference of them for point force ($M = F \times X$).



Fig 3-nonlinear/linear deflection under point force



Fig 4-diffrence between nonlinear and linear deflections



Fig 5-relative error of linear analysis

4. Ansys Analysis

In second stage, we simulated the Membrane .The used element is Shell 93. This element is nonlinear.



Fig 6- Ansys analysis

	compareing the results		
	Linear	Nonlinear	Ansys
Max deflection	4.54e-6	4.67e-6	4.53e-6
Max deference	1.37e-8	0	1.38e-7
Max Error	10%	0	10%

Table 2

5. Solution of O.D.E for distributed force

Distributed forces are associated as an important kind of forces which act along the membrane. By function runge we solved the below.

L=190 µm f=0.02222 N/m E=70 GPa
$$I = (\frac{9}{40})\mu m^4$$



Fig 7-nonlinear/linear deflection Under distributed force



Fig 8-diffrence between nonlinear and linear deflections



Fig 9-relative error of linear analysis



Fig 10- Ansys analysis

	Table 3				
	Linear	Nonlinear	Ansys		
Max deflection	6.03e-6	5.94e-6	3.5e-6		
Max deference	1.37e-7	0	err		
Max Error	6%	0	Err		

6. Taylor Method

Taylor expansion create the below polynomial from order 13, which we couldn't increase the order.



Fig 11-Taylor expiation of O.D.E solution

Then we compared the nonlinear analysis with Taylor solution for point force.







Fig 13-diffrence between nonlinear and linear deflections

7. Effect of force on nonlinearity

For predict of force effect, we wrote a function in Macsyma that calculates the maximum deflection of Membrane under any kind of force on it, in form of

$$M = \frac{a}{2} \times \left(\frac{l}{4} - x\right) \text{ in a range of a0$$

runge(n,1,y0,dy0,a0,an,v,m,e,ii)=

Fig14-The shape of function

Table 4					
the argument of function					
n	number of	y0	B.C		
	differences				
1	length	dy0	B.C		
a0	The first	an	The last		
	Coefficient of		Coefficient of		
	moment		moment		
e	Module of	Ii	Momentum of		
	elasticity		inertia		
m	Power of	V	Step of		
	Moment		moment		

runge(100,190*10^-6,0,0,1*10^-6,4*10^-6,10^-7,1,70*10^9,9/4*10^-25) Fig15-The Data of function



Fig16- Maximum deflection of membrane Under different forces



Fig17-Error of Maximum deflection of memberane Under different forces

8. Conclusion

The results of comparison showed that nonlinearity increases exponentially by decreasing the dimensions, and when we compare the effect of point force with distributed force on linear and nonlinear analysis, it is clear that increasing the force, increases the nonlinearity. So, by considering the all references, works and current work, it seems that because the nonlinearity has a very wide effect on the Micro levels, all analyses must be considered nonlinear. The nonlinearity effects exponentially in Micro level, it is not predictable in which dimensions we can use the linear analysis, so for tale safe side it is good to use the nonlinear analysis in all cases.

9. References

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